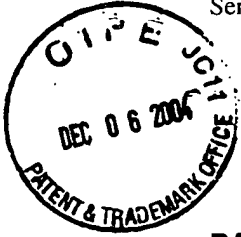


Serial No. 10/816527



IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE

PATENT APPLICATION

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**Raymond A Cirelli**  
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Serial No.: **10/816527**  
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Examiner: \_\_\_\_\_ Group Art Unit: **2811**  
Title: **Nanostructures For High Density Interconnection**

COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
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SIR:

Transmitted herewith are six (6) sheets of formal drawings to be substituted for the informal drawings initially filed in the above-identified application for patent.

**No additional fee is required.**

In the event of non-payment or improper payment of a required fee, the Commissioner is authorized to charge or to credit **Deposit Account No. 12-2325** as required to correct the error.

Respectfully,

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Date: 12/1/04

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Date of Deposit Dec. 1, 2004

I hereby certify that this correspondence is being deposited with the United States Postal Service First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date indicated above.

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